

**DUAL 30V N-CHANNEL ENHANCEMENT MODE MOSFET****SUMMARY****V<sub>(BR)DSS</sub>=30V; R<sub>DS(ON)</sub>=0.135Ω; I<sub>D</sub>=2.3A****DESCRIPTION**

This new generation of high density MOSFETs from Zetex utilises a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

**MSOP8****FEATURES**

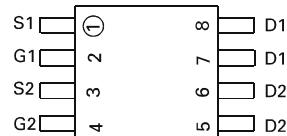
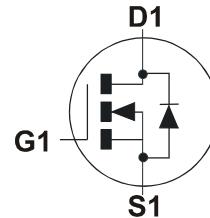
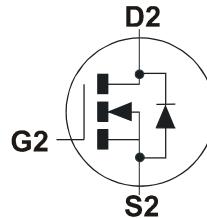
- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- Low profile SOIC package

**APPLICATIONS**

- DC - DC Converters
- Power Management Functions
- Disconnect switches
- Motor control

**ORDERING INFORMATION**

| DEVICE       | REEL SIZE<br>(inches) | TAPE WIDTH (mm) | QUANTITY<br>PER REEL |
|--------------|-----------------------|-----------------|----------------------|
| ZXMD63N03XTA | 7                     | 12mm embossed   | 1000 units           |
| ZXMD63N03XTC | 13                    | 12mm embossed   | 4000 units           |

**DEVICE MARKING**

- ZXM63N03

# ZXMD63N03X

## ABSOLUTE MAXIMUM RATINGS.

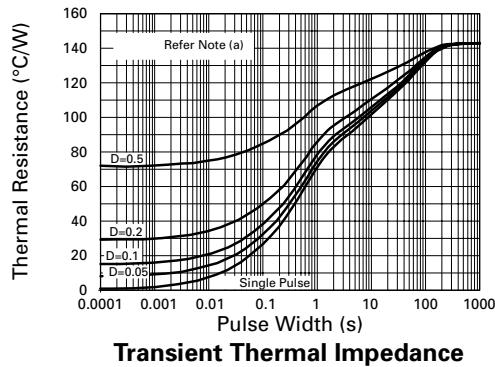
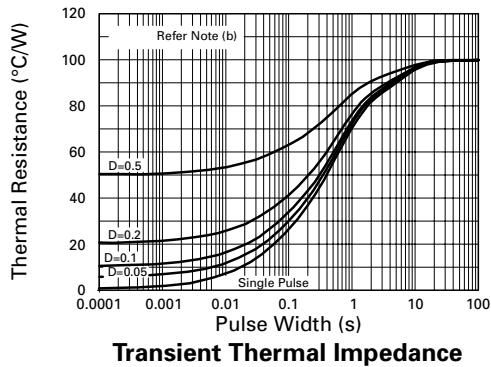
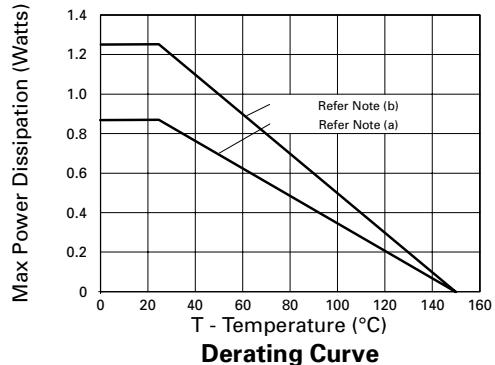
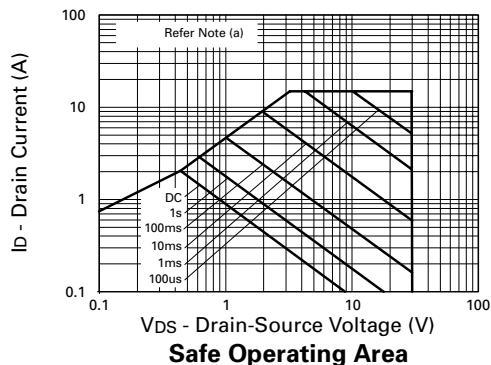
| PARAMETER   | SYMBOL         | LIMIT       | UNIT                |
|---|----------------|-------------|---------------------|
| Drain-Source Voltage  | $V_{DSS}$      | 30          | V                   |
| Gate- Source Voltage  | $V_{GS}$       | $\pm 20$    | V                   |
| Continuous Drain Current ( $V_{GS}=4.5V$ ; $T_A=25^\circ C$ )(b)(d)<br>( $V_{GS}=4.5V$ ; $T_A=70^\circ C$ )(b)(d) | $I_D$          | 2.3<br>1.8  | A                   |
| Pulsed Drain Current (c)(d)   | $I_{DM}$       | 14          | A                   |
| Continuous Source Current (Body Diode)(b)(d)  | $I_S$          | 1.5         | A                   |
| Pulsed Source Current (Body Diode)(c)(d)  | $I_{SM}$       | 14          | A                   |
| Power Dissipation at $T_A=25^\circ C$ (a)(d)<br>Linear Derating Factor  | $P_D$          | 0.87<br>6.9 | W<br>mW/ $^\circ C$ |
| Power Dissipation at $T_A=25^\circ C$ (a)(e)<br>Linear Derating Factor  | $P_D$          | 1.04<br>8.3 | W<br>mW/ $^\circ C$ |
| Power Dissipation at $T_A=25^\circ C$ (b)(d)<br>Linear Derating Factor  | $P_D$          | 1.25<br>10  | W<br>mW/ $^\circ C$ |
| Operating and Storage Temperature Range   | $T_j; T_{stg}$ | -55 to +150 | $^\circ C$          |

## THERMAL RESISTANCE

| PARAMETER                  | SYMBOL          | VALUE | UNIT         |
|----------------------------|-----------------|-------|--------------|
| Junction to Ambient (a)(d) | $R_{\theta JA}$ | 143   | $^\circ C/W$ |
| Junction to Ambient (b)(d) | $R_{\theta JA}$ | 100   | $^\circ C/W$ |
| Junction to Ambient (a)(e) | $R_{\theta JA}$ | 120   | $^\circ C/W$ |

### NOTES

- (a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions
- (b) For a device surface mounted on FR4 PCB measured at  $t \leq 10$  secs.
- (c) Repetitive rating - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.
- (d) For device with one active die.
- (e) For device with two active die running at equal power.

**CHARACTERISTICS**

# ZXMD63N03X

## ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^\circ C$ unless otherwise stated).

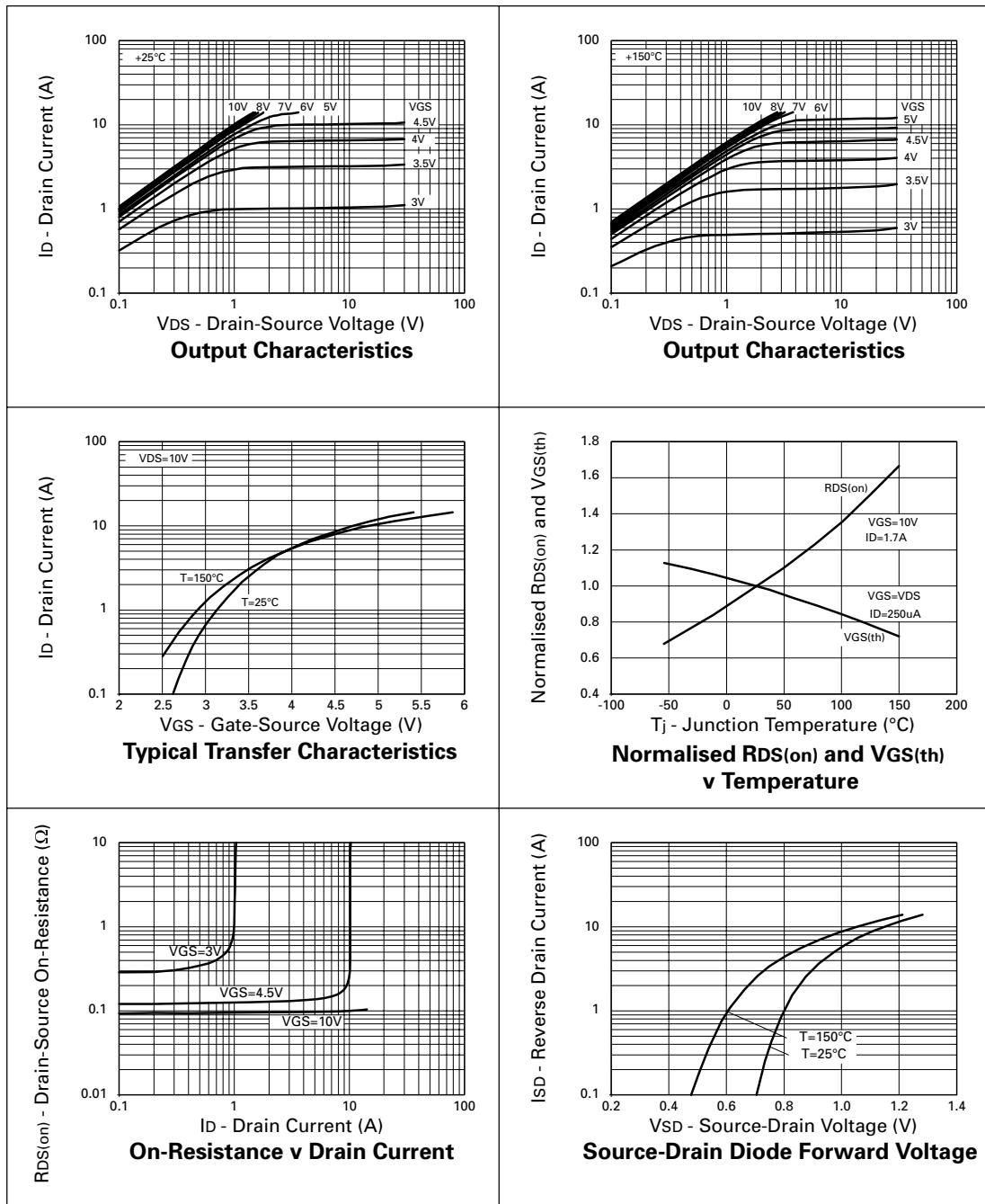
| PARAMETER                                   | SYMBOL        | MIN. | TYP. | MAX.           | UNIT   | CONDITIONS.   |
|---|---------------|------|------|----------------|--|---|
| <b>STATIC</b>                               |               |      |      |                |  |   |
| Drain-Source Breakdown Voltage              | $V_{(BR)DSS}$ | 30   |      |                | V  | $I_D=250\mu A, V_{GS}=0V$   |
| Zero Gate Voltage Drain Current             | $I_{DSS}$     |      |      | 1              | $\mu A$  | $V_{DS}=30V, V_{GS}=0V$   |
| Gate-Body Leakage                           | $I_{GSS}$     |      |      | 100            | nA   | $V_{GS}=\pm 20V, V_{DS}=0V$   |
| Gate-Source Threshold Voltage               | $V_{GS(th)}$  | 1.0  |      |                | V  | $I_D=250\mu A, V_{DS}=V_{GS}$   |
| Static Drain-Source On-State Resistance (1) | $R_{DS(on)}$  |      |      | 0.135<br>0.200 | $\Omega$   | $V_{GS}=10V, I_D=1.7A$<br>$V_{GS}=4.5V, I_D=0.85A$                                  |
| Forward Transconductance (3)                | $g_{fs}$      | 1.9  |      |                | S  | $V_{DS}=10V, I_D=0.85A$   |
| <b>DYNAMIC (3)</b>                          |               |      |      |                |  |   |
| Input Capacitance                           | $C_{iss}$     |      | 290  |                | pF   | $V_{DS}=25 V, V_{GS}=0V,$<br>$f=1MHz$   |
| Output Capacitance                          | $C_{oss}$     |      | 70   |                | pF   |   |
| Reverse Transfer Capacitance                | $C_{rss}$     |      | 20   |                | pF   |   |
| <b>SWITCHING(2) (3)</b>                     |               |      |      |                |  |   |
| Turn-On Delay Time                          | $t_{d(on)}$   |      | 2.5  |                | ns   | $V_{DD}=15V, I_D=1.7A$<br>$R_G=6.1\Omega, R_D=8.7\Omega$<br>(Refer to test circuit) |
| Rise Time                                   | $t_r$         |      | 4.1  |                | ns   |   |
| Turn-Off Delay Time                         | $t_{d(off)}$  |      | 9.6  |                | ns   |   |
| Fall Time                                   | $t_f$         |      | 4.4  |                | ns   |   |
| Total Gate Charge                           | $Q_g$         |      | 8    | nC             | $V_{DS}=24V, V_{GS}=10V,$<br>$I_D=1.7A$<br>(Refer to test circuit) |   |
| Gate-Source Charge                          | $Q_{gs}$      |      | 1.2  | nC             |  |   |
| Gate Drain Charge                           | $Q_{gd}$      |      | 2    | nC             |  |   |
| <b>SOURCE-DRAIN DIODE</b>                   |               |      |      |                |  |   |
| Diode Forward Voltage (1)                   | $V_{SD}$      |      |      | 0.95           | V  | $T_i=25^\circ C, I_S=1.7A,$<br>$V_{GS}=0V$  |
| Reverse Recovery Time (3)                   | $t_{rr}$      |      | 16.9 |                | ns   | $T_i=25^\circ C, I_F=1.7A,$<br>$dI/dt= 100A/\mu s$                                  |
| Reverse Recovery Charge(3)                  | $Q_{rr}$      |      | 9.5  |                | nC   |   |

(1) Measured under pulsed conditions. Width=300 $\mu s$ . Duty cycle  $\leq 2\%$ .

(2) Switching characteristics are independent of operating junction temperature.

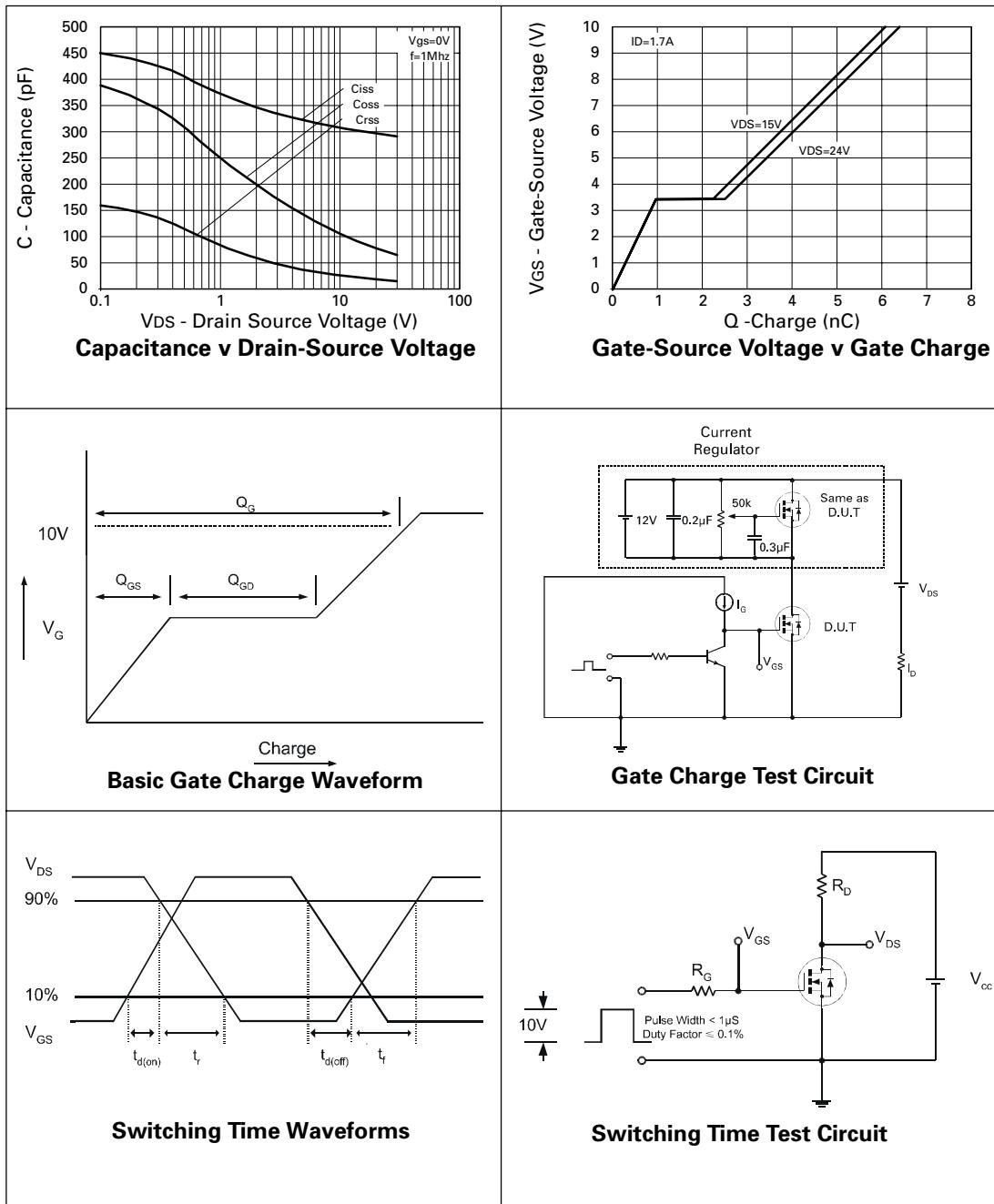
(3) For design aid only, not subject to production testing.

## TYPICAL CHARACTERISTICS



# ZXMD63N03X

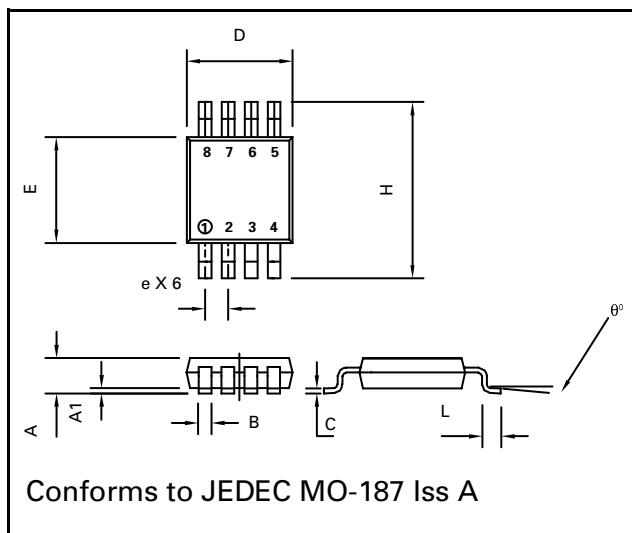
## TYPICAL CHARACTERISTICS



**ZXMD63N03X**

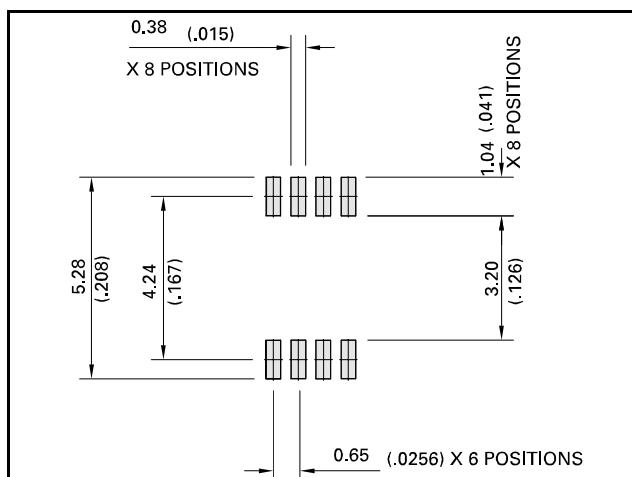
# ZXMD63N03X

## PACKAGE DIMENSIONS



| DIM | Millimetres |      | Inches |       |
|-----|-------------|------|--------|-------|
|     | MIN         | MAX  | MIN    | MAX   |
| A   |             |      | 1.10   | 0.043 |
| A1  | 0.05        | 0.15 | 0.002  | 0.006 |
| B   | 0.25        | 0.40 | 0.010  | 0.016 |
| C   | 0.13        | 0.23 | 0.005  | 0.009 |
| D   | 2.90        | 3.10 | 0.114  | 0.122 |
| e   | 0.65        | BSC  | 0.0256 | BSC   |
| E   | 2.90        | 3.10 | 0.114  | 0.122 |
| H   | 4.90        | BSC  | 0.193  | BSC   |
| L   | 0.40        | 0.70 | 0.016  | 0.028 |
| q°  | 0°          | 6°   | 0°     | 6°    |

## PAD LAYOUT DETAILS



# ZETEX

Zetex plc.

Fields New Road, Chadderton, Oldham, OL9-8NP, United Kingdom.  
Telephone: (44)161 622 4422 (Sales), (44)161 622 4444 (General Enquiries)  
Fax: (44)161 622 4420

Zetex GmbH  
Streifeldstraße 19  
D-81673 München  
Germany  
Telefon: (49) 89 45 49 49 0  
Fax: (49) 89 45 49 49 9

Zetex Inc.  
47 Mall Drive, Unit 4  
Commack NY 11725  
USA  
Telephone: (516) 543-7100  
Fax: (516) 864-7630

Zetex (Asia) Ltd.  
3510 Metroplaza, Tower 2  
Hing Fong Road,  
Kwai Fong, Hong Kong  
Telephone: (852) 26100 611  
Fax: (852) 24250 494

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